

isc N-Channel Mosfet Transistor

BUZ35

FEATURES

- Static Drain-Source On-Resistance
 - : $R_{DS(on)} = 0.4 \Omega (Max)$
- SOA is Power Dissipation Limited
- · High speed switching
- Minimum Lot-to-Lot variations for robust device performance and reliable operation

DESCRITION

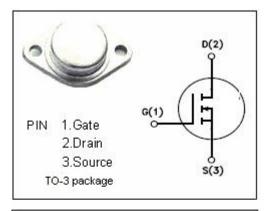
Designed for applications such as switching regulators, switching converters, motor drivers, relay drivers and drivers for high power bipolar switching transistors requiring high speed and low gate drive power.

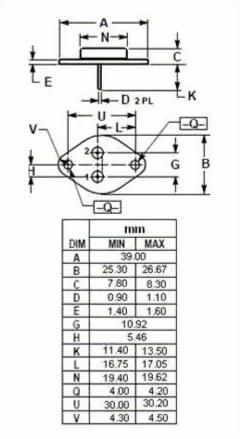
• ABSOLUTE MAXIMUM RATINGS(Ta=25°C)

| SYMBOL | ARAMETER | VALUE | UNIT |
|------------------|---|---------|------------------------|
| V _{DSS} | Drain-Source Voltage (V _{GS} =0) | 200 | V |
| V _{GS} | Gate-Source Voltage | ±20 | V |
| I _D | Drain Current-continuous@ TC=25℃ | 9.9 | Α |
| I _{DM} | Drain Current-Single Plused | 39 | Α |
| P _{tot} | Total Dissipation@TC=25℃ | 78 | W |
| T _j | Max. Operating Junction Temperature 150 | | $^{\circ}\!\mathbb{C}$ |
| T _{stg} | Storage Temperature Range | -55~150 | $^{\circ}\!\mathbb{C}$ |

THERMAL CHARACTERISTICS

| SYMBOL | PARAMETER | MAX | UNIT |
|---------------------|--|-----|------|
| R _{th j-c} | Thermal Resistance,Junction to Case | 1.6 | °C/W |
| R _{th j-a} | R _{th j-a} Thermal Resistance,Junction to Ambient | | °C/W |







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ELECTRICAL CHARACTERISTICS

T_C=25℃ unless otherwise specified

| SYMBOL | PARAMETER | CONDITIONS | MIN | TYPE | MAX | UNIT |
|----------------------|---------------------------------|---|-----|------|------|------|
| V _{(BR)DSS} | Drain-Source Breakdown Voltage | V _{GS} = 0; I _D =0.25mA | 200 | | | V |
| V _{GS(th)} | Gate Threshold Voltage | V _{DS} = V _{GS} ; I _D =1mA | 2.1 | | 4.0 | V |
| V _{SD} | Diode Forward On-voltage | I _S = 20A;V _{GS} = 0 | | | 1.7 | V |
| R _{DS(on)} | Drain-Source On-Resistance | V _{GS} = 10V; I _D = 4.5A | | | 0.4 | Ω |
| Igss | Gate-Body Leakage Current | V _{GS} = ±20V;V _{DS} = 0 | | | ±100 | nA |
| I _{DSS} | Zero Gate Voltage Drain Current | V _{DS} =200V; V _{GS} = 0 | | | 250 | μΑ |
| Gfs | Forward Transconductance | V _{DS} = 25V; I _D =4.5A | 2.2 | | | S |
| t _{d(on)} | Turn-on Delay Time | V _{GS} =10V; | | | 45 | |
| t _r | Rise Time | I _D =2.9A; | | | 60 | |
| $t_{\sf d(off)}$ | Turn-off Delay Time | V_{DD} =30V; R_{GS} =50 Ω | | | 140 | ns |
| t _f | Fall Time | | | | 80 | |

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